



Product Change Notification

Change Notification #: 116635 - 00
Change Title: Intel® Server System R1304WT2GSR,
Intel® Server System R2312WTTYSR,
Intel® Server Chassis R2000WTXXX,
PCN 116635-00, Label,
Updating Outer Box Label Logo

Date of Publication: December 10, 2018

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	December 26, 2018
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

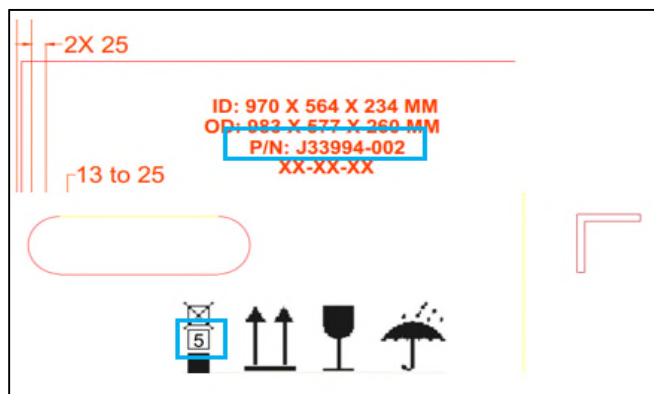
Description of Change to the Customer:

Intel is updating the outer box label logo of the Intel Server Chassis and the Intel Server Systems listed in the products affected table below.

The previous logo means that the maximum layers supported in a pallet are 7 in total, however only 6 layers as maximum can be supported. The P/N (Product Number) of the label is being updated for listed products as follow.

- Intel Server 1U Systems and 1U Chassis updates the P/N from J34109-001 to J34109-002.
- Intel Server 2U Systems and 2U Chassis updates the P/N from J34107-001 to J34107-002.

The Image below shows an example of the label logo P/N update.



Outer Box Label Logo Example

Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R2312WTTYSR	975761	J11495-016	J11495-017
R1304WT2GSR	977053	J11483-014	J11483-015
R2000WTXXX	977059	H46995-008	H46995-009

PCN Revision History:

Date of Revision:

December 10, 2018

Revision Number:

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Reason:

Originally Published PCN



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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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